ROLL NO.	

Subject: ENGINEERING MATERIALS Code: DE54 / DE104

DiplETE - ET (Current & New Scheme)

June 2018 Time: 3 Hours Max. Marks: 100

PLEASE WRITE YOUR ROLL NO. AT THE SPACE PROVIDED ON EACH PAGE IMMEDIATELY AFTER RECEIVING THE QUESTION PAPER.

NOTE: There are 9 Questions in all.

- Question 1 is compulsory and carries 20 marks. Answer to Q.1 must be written in the space provided for it in the answer book supplied and nowhere else.

Q.1	Cl	Choose the correct or the best alternative in the following:				
	a.	a. Materials which lack permanent magnetic dipoles are called				
		(A) diamagnetic	(B) ferromagnetic			
		(C) semi magnetic	(D) None of these			
	b.	A bipolar transistor is a controlled device.	_ controlled device, whereas an FET is a			
		(A) current, voltage	(B) current, current			
		(C) voltage, current	(D) voltage, voltage			
	c.	 In ferromagnetic materials (A) The atomic magnetic moments (B) The atomic magnetic moments (C) The constitute is iron only (D) One of the constituent is iron 				
	d.	Thermionic emission occurs in (A) Transistors (C) Copper conductors	(B) Ferrite cores(D) Semi-conductors			
	e.	High conductivity Aluminium sho (A) Steel rod reinforcement (C) High dislocation density	uld have (B) Solute atoms such as Cu, Ag and Au (D) Dissolved impurities			
	f.	In the polarization versus field stre (A) Space charge polarization (C) Spontaneous polarization	ength plot for a ferroelectric crystal, Ps stands for (B) Saturation polarization (D) None of these			
	g.	Zone refining is used for purificati	on of			

(A) conductors **(B)** insulators (C) alloys (**D**) semiconductors

h. Dielectric material is essentially

(A) Insulating material (B) Conducting material (C) Semi conducting material (**D**) Ferro-electric material

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	i.	Which of the following materials is best (A) Copper	est for cable shields? (B) Mica	
		(C) Cast iron	(D) Lead	
	j.		(B) an amplifier (D) a coupler	
		Answer any FIVE Questions o Each question carri	-	
Q.2	a.	What is contact potential? Draw & exp two metals before & after contact.	plain the energy distribution of electrons in	(8)
	b.	Explain temperature dependence of conductors and semiconductors.	electrical resistivity and conductivity in	(8)
Q.3	a.	Explain the phenomena of polarization.		(8)
	b.	Derive Clausius-Mossotti relation for di	electric constant \in_{r} and Polarisability α .	(8)
Q.4	a.	Explain properties and application of po	lymers.	(9)
	b.	Explain Dielectric breakdown in gasses.		(7)
Q.5	a.	What is the origin of permanent magnaramagnetism.	gnetic dipoles? Discuss diamagnetism and	(8)
	b.	Explain ferromagnetic domains and their	r origin.	(8)
Q.6	a.	What are the different types of se semiconductor with the help of energy b	miconductor? Explain n-type and p-type and diagram.	(8)
	b.	Explain the following: (i) Thermal conductivity of semiconductivity of doped mat	ors	4x2)
Q.7	a.	What is a PN junction? Draw and explain	n V-I characteristic of a PN junction diode.	(8)
	b.	What is junction transistor? Describe in transistors.	brief the working of two types of junction	(8)
Q.8	a.	The resistance of a wire is 60Ω at 25° wire at 10° C and value of temperature c	$^{\circ}$ C and 65 Ω at 75 $^{\circ}$ C. Find the resistance of oefficients at 0 $^{\circ}$ C.	(8)
	b.	What is Metal Oxide film resistor?		(8)
Q.9	a.	Explain the operation of JFET with characteristics.	low drain voltage and draw the drain	(10)
	b.	What is epitaxial diffused junction diode	e? Explain in brief.	(6)